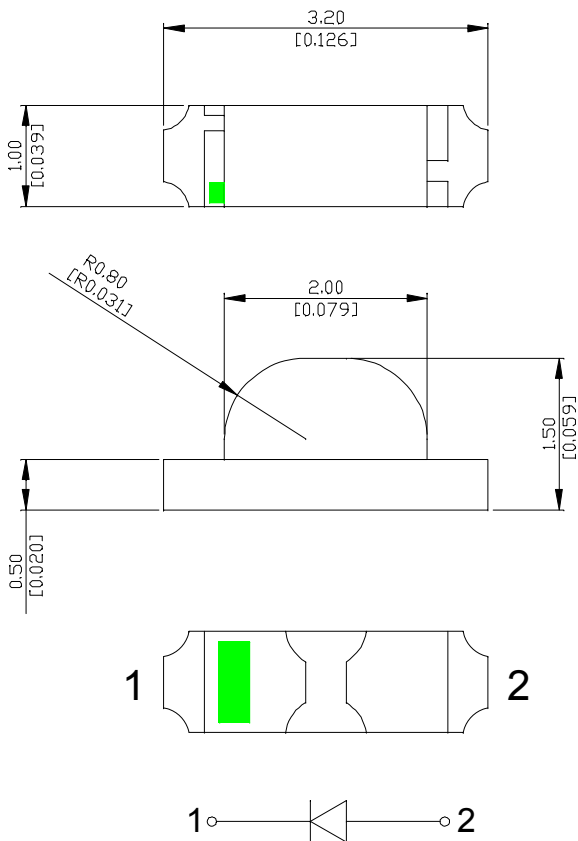



## Feature

- ◆ Viewing angle:160 deg
- ◆ The materials of the LED dice is AlGaInP
- ◆ 3.2mm×1.0mm×1.5mm
- ◆ RoHS compliant lead-free soldering compatible

## CC-GST1204TS-BC

## Package Outline





**ATTENTION**

OBSERVE PRECAUTIONS  
FOR HANDLING  
ELECTROSTATIC  
SENSITIVE DEVICES

## NOTES:

1. All dimensions are in millimeters (inches);
2. Tolerances are  $\pm 0.1\text{mm}$  (0.004inch) unless otherwise noted.

### Absolute maximum ratings at Ta=25°C

Parameter	Symbol	Value	Unit
Power dissipation	Pd	48	mW
Forward current	If	20	mA
Reverse voltage	Vr	5	V
Operating temperature range	Top	-40 ~+100	°C
Storage temperature range	Tstg	-40~+100	°C
Pulse Forward Current	I <sub>fp</sub>	100	mA
Electrostatic Discharge	ESD	2000(HBM)	V

### Electro-optical characteristics at Ta=25°C

Parameter	Test Condition	Symbol	Value			Unit
			Min.	Typ.	Max.	
Spectral half bandwidth	If=20mA	$\Delta\lambda$	--	15	--	nm
Forward voltage	If=20mA	Vf	1.8	--	2.4	V
Dominant wavelength	If=20mA	$\lambda_d$	560	--	575	nm
Luminous intensity	If=20mA	Iv	12	--	85	mcd
Viewing angle at 50% Iv	If=20mA	2 $\theta$ 1/2	--	160	--	Deg
Reverse current	Vr=5V	Ir	--	--	10	$\mu$ A

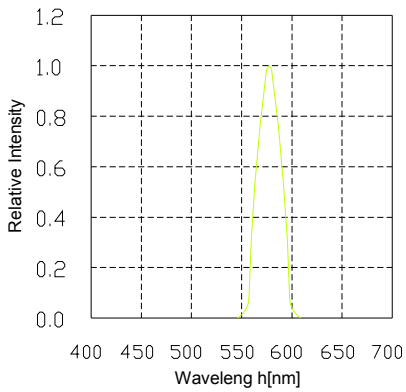
NOTE: (Tolerance: Iv  $\pm$ 10%,  $\lambda_d$   $\pm$ 2nm, Vf  $\pm$ 0.05V)

I<sub>FP</sub> Conditions: Pulse Width  $\leq$  10msec. and Duty  $\leq$  1/10.

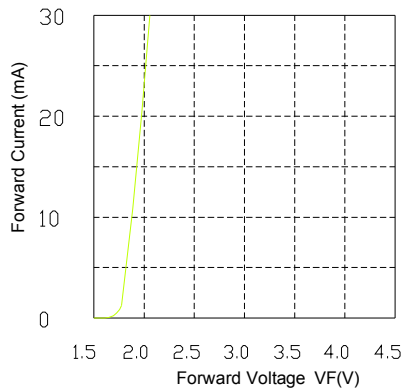
## Typical optical characteristics curves

### Spectral Distribution

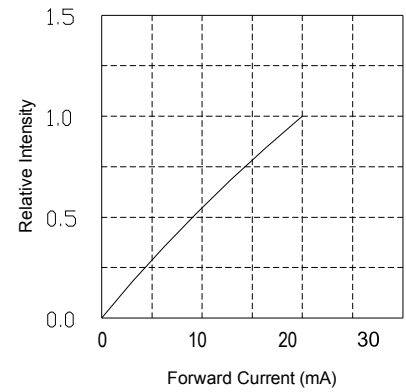
Relative Intensity vs. Wavelength (Ta=25°C)



Forward Voltage vs. Forward Current (Ta=25°C)

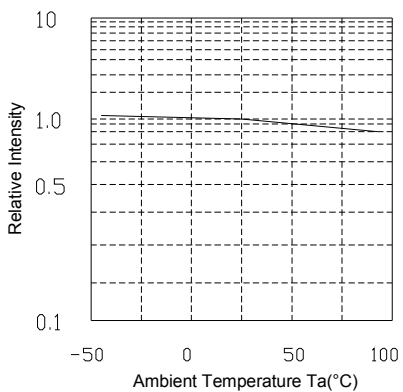


Relative Intensity vs. Forward Current (Ta=25°C)

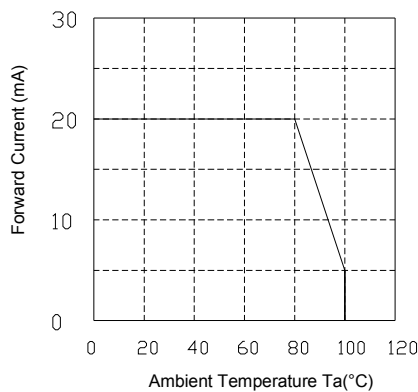


### Derating

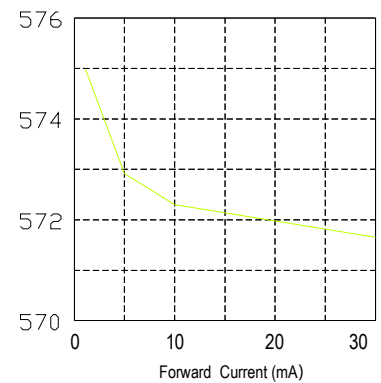
Relative Intensity vs. Ambient Temperature



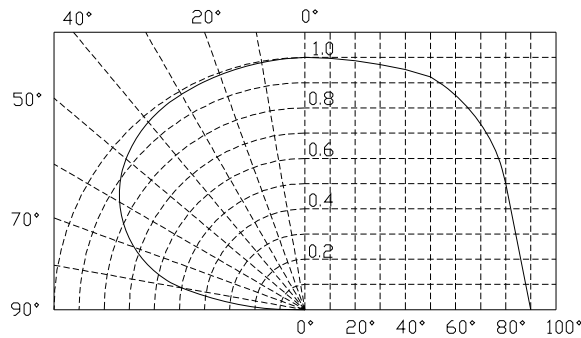
Ambient Temperature vs. Maximum Forward Current



Forward Current vs. Dominate wavelength (Ta=25°C)



### Diagram characteristics of radiation



## Reflow profile

### ■ Soldering condition

- Recommended soldering conditions

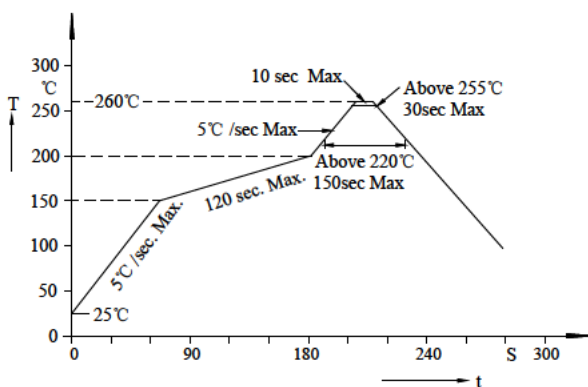
Reflow Soldering		Hand Soldering	
Pre-heat	160~180°C	Temperature	300°C Max.
Pre-heat time	120 seconds Max.	Soldering time	3 second Max. (one time only)
Peak temperature	260°C Max.		
Soldering time	10 seconds Max.		
Condition	Refer to Temperature-profile		

- After reflow soldering rapid cooling should be avoided

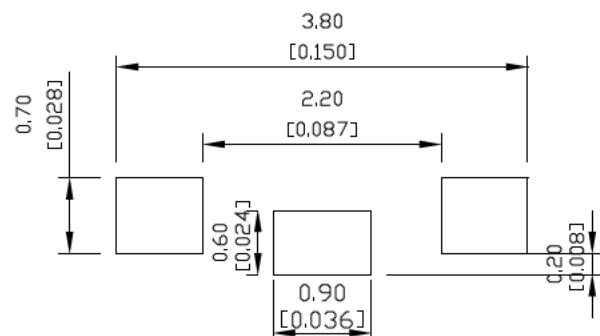
### ■ Temperature-profile (Surface of circuit board)

Use the following conditions shown in the figure.

IR-Reflow Soldering Profile for lead Soldering



### RECOMMEND PAD DESIGN (Units: mm)



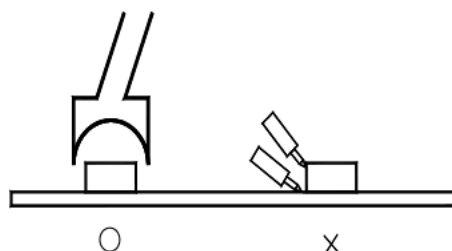
1. Reflow soldering should not be done more than two times
2. When soldering ,do not put stress on the LEDs during heating

### ■ Soldering iron

1. When hand soldering, keep the temperature of the iron under 300°C, and at that temperature keep the time under 3 sec.
2. The hand soldering should be done only a time
3. The basic spec is  $\leq 5$  sec. when the temperature of 260°C, do not contact the resin when hand soldering

### ■ Rework

1. Customer must finish rework within 5 sec under 260°C
2. The head of iron can not touch the resin
3. Twin-head type is preferred.



## Reliability

### (1) TEST ITEMS AND RESULTS

Type	Test Item	Ref. Standard	Test Conditions	Note	Number of Damaged
Environmental Sequence	Resistance to Soldering Heat(Reflow Soldering)	JESD22-B106	Tsld=260°C,10sec	2 times	0/22
	Temperature Cycle	JESD22-A104	-40°C 30min ↑↓5min 100°C 30min	300 cycle	0/22
	Thermal Shock	JESD22-A106	-40°C 15min ↑↓ 100°C 15min	300 cycle	0/22
	High Temperature Storage	JESD22-A103	T <sub>a</sub> =100°C	1000 hrs	0/22
	Low Temperature Storage	JESD22-A119	T <sub>a</sub> =-40°C	1000 hrs	0/22
Operation Sequence	Life Test	JESD22-A108	T <sub>a</sub> =25°C I <sub>F</sub> =20mA	1000 hrs	0/22
	High Humidity Heat Life Test	JESD22-A101	60°C RH=90% I <sub>F</sub> =20mA	1000 hrs	0/22

### (2) CRITERIA FOR JUDGING THE DAMAGE

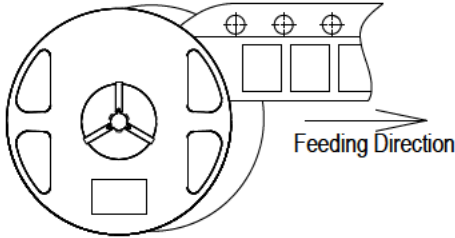
Item	Symbol	Test Conditions	Criteria for Judgement	
			Min.	Max.
Forward Voltage	VF	IF=20mA	-	U.S.L*)×1.1
Reverse Current	IR	VR=5V	-	U.S.L*)×2.0
Luminous Intensity	IV	IF=20mA	L.S.L**)×0.7	-

U.S.L.: Upper Standard Level

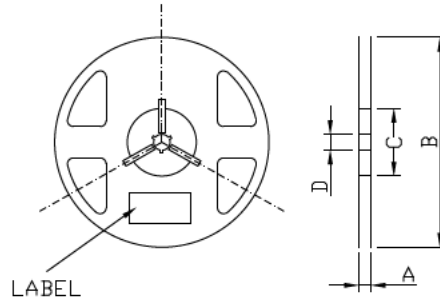
L.S.L.: Lower Standard Level

## Packaging Specifications

### ● Feeding Direction

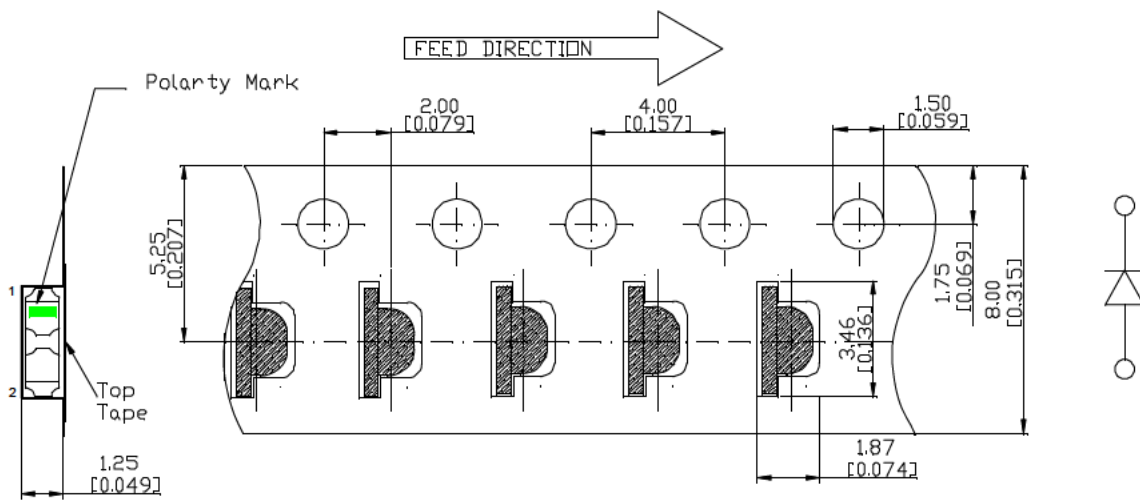


### ● Dimensions of Reel (Unit: mm)

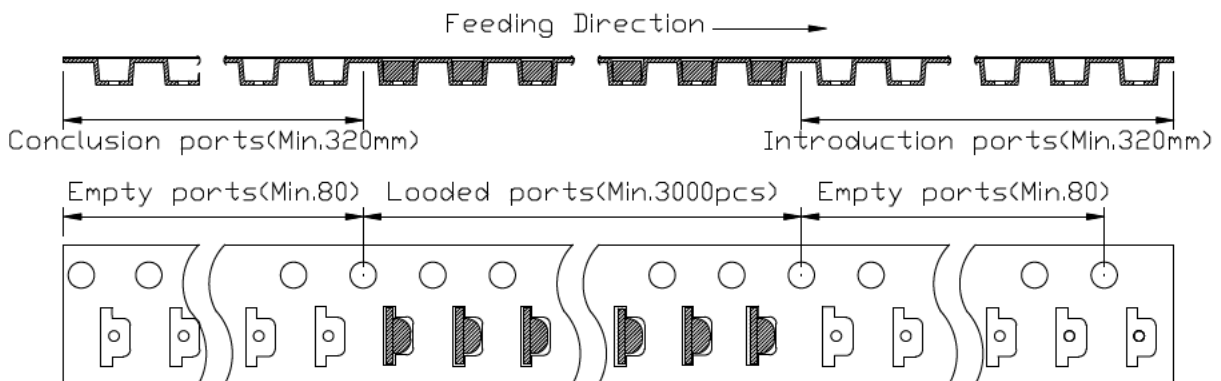


A	$8.0 \pm 0.1\text{mm}$
B	$178 \pm 1\text{mm}$
C	$60 \pm 1\text{mm}$
D	$13.0 \pm 0.5\text{mm}$

### ● Dimensions of Tape (Unit: mm)



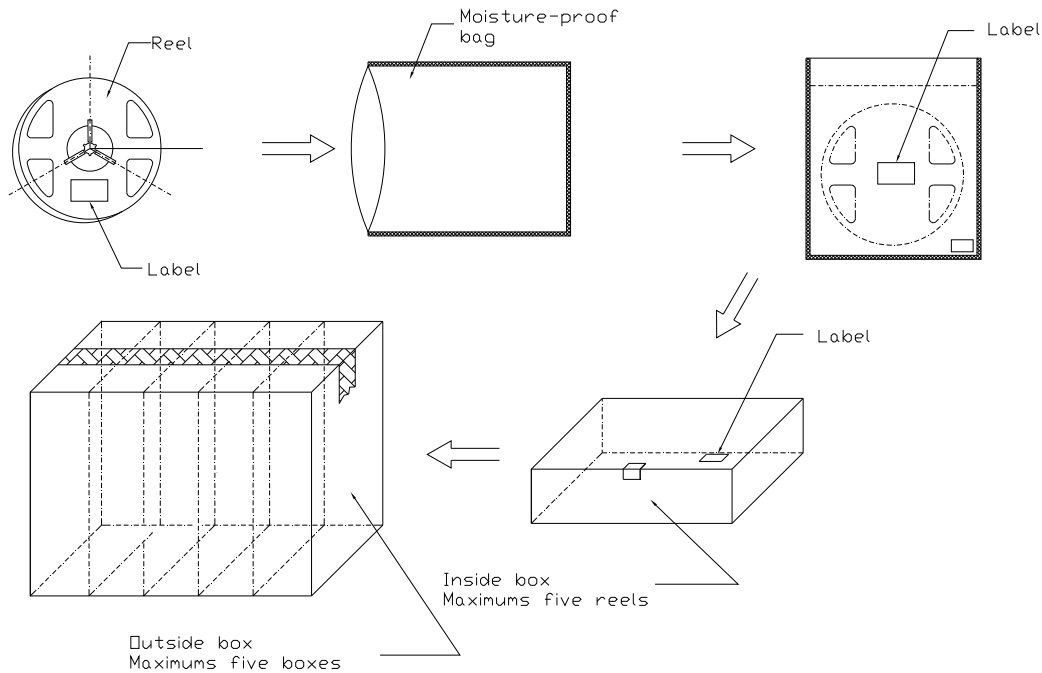
### ● Arrangement of Tape





## NOTES

1. Empty component pockets are sealed with top cover tape;
2. The maximum number of missing lamps is two;
3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
4. 3,000 pcs/ Reel.

## Packaging specifications



### ■ Label

<p>P/N:            LOT NO:          BIN CODE:  </p> <p style="text-align: right;">QTY:    PCS          DATE:</p>
--

## CAUTIONS

### Package specifications

Reeled products (numbers of products are 3,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, Five moisture-proof bag of maximums (total maximum number of products are 15,000pcs) packed in an inside box (size: about 250mm x about 250 x about 68mm) and Five inside boxes of maximums are put the outside box (size: about 360mm x about 265mm x about 255mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has three steps.

### Storage conditions

#### Before opening the package:

The LEDs should be kept at 30°C or less and 70%RH or less. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with absorbent material is recommended.

#### After opening the package:

The LEDs should be kept at 30°C or less and 60%RH or less. The LEDs should be soldered within 168 hours (7days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material. It is also recommended to return the LEDs to the original moisture proof bag and to reseal the moisture proof bag again.